

EU DECLARATION OF CONFORMITY

Model: SDC001 (Rosewood7 1D)

I. Product Safety and EMC Compliance

A. The Electromagnetic Compatibility (EMC) Directive 2014/30/EU by application of the following standards:

EN 55032:2012/AC: 2013 Electromagnetic compatibility of multimedia equipment —

Emission requirements.

EN 55024:2010 Information technology equipment – Immunity characteristics –

Limits and methods of measurement

EN 61000-3-2:2014 Electromagnetic compatibility (EMC) - Part 3-2: Limits for

harmonic current emissions (equipment input current <= 16 A

per phase).

EN 61000-3-3:2013 Electromagnetic compatibility (EMC) - Part 3-3: Limitation of

voltage changes, voltage fluctuations and flicker in public low-voltage supply systems, for equipment with rated current

<= 16 A per phase.

B. The product (s) meets the requirements of The Low Voltage Directive (LVD) 2014/35/EU by application of the following standard(s):

EN 60950-1:2006 Information technology equipment - Safety - General

requirements. (Second Edition) Part 1: +A11:2009 +A1:2010

+A12:2011+ A2:2013.

EN 62368-1:2014 Audio/video, information and communication technology

equipment - Part 1: Safety requirements (IEC 62368-1:2014,

modified)

II. Product Environmental Compliance, EU/China RoHS Declaration of Conformity

- A. Conformity with Harmonized Standards/Technical Specifications:
- Directive 2011/65/EU RoHS "Recast" (RoHS 2) as amended by Directive (EU) 2015/863 and further amended by Directive 2018/739 and Directive 2018/740 EN 50581:2012
- Management Methods for Controlling Pollution by Electronic Information Products, Ministry of Information Industry Order No. 39 (China RoHS)
- Management Methods for the Restriction of the Use of Hazardous Substances in electrical and Electronic Products, Ministry of Industry and Information Technology Order No. 32 effective July 1, 2016 (China RoHS 2)
- 4. Joint JEDEC/ECA Standard, Definition of "Low-Halogen" for Electronic Products, JS709B

B. Seagate products rely on the following RoHS 2 exemptions for compliance:

Exemption Description
6(a)-I. Lead as an alloying element in steel for machining purposes containing up to 0.35% lead by weight and in batch hot dip galvanised steel components containing up to 0.2% lead by weight
6(b)-II. Lead as an alloying element in aluminum for machining purposes up to 0.4% lead by weight
6c. Copper alloy up to 0.4% lead by weight
7a. Lead in high melting temperature type solders (i.e. lead-based solder alloys containing 85 % by weight or more lead
7(c)-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors (e.g. piezoelectronic devices) or in a glass or ceramic matrix compound

This product or products are in conformity with the relevant Union harmonization legislation. This declaration of conformity is issued under the sole responsibility of Seagate Technology International.

Date of Issue: Sep 24, 2018 Signature:

Azeez Talha Engineering Director Reliability Technology Engineering

Signed for and on behalf of:

Seagate Technology International Koolhovenlaan 1 1119 NB Schiphol-Rijk The Netherlands